

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L²-π-MOSV)

2SK3387

Switching Regulator, DC-DC Converter and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON resistance: $R_{DS(ON)} = 0.08 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 17 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \mu\text{A}$ ($V_{DS} = 150 \text{ V}$)
- Enhancement mode: $V_{th} = 0.8 \sim 2.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit |
|--|----------------|----------|------|
| Drain-source voltage | V_{DSS} | 150 | V |
| Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | V_{DGR} | 150 | V |
| Gate-source voltage | V_{GSS} | ± 20 | V |
| Drain current | DC (Note 1) | I_D | 18 |
| | Pulse (Note 1) | I_{DP} | 54 |
| Drain power dissipation ($T_c = 25^\circ\text{C}$) | P_D | 100 | W |
| Single pulse avalanche energy (Note 2) | E_{AS} | 176 | mJ |
| Avalanche current | I_{AR} | 18 | A |
| Repetitive avalanche energy (Note 3) | E_{AR} | 10 | mJ |
| Channel temperature | T_{ch} | 150 | °C |
| Storage temperature range | T_{stg} | -55~150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

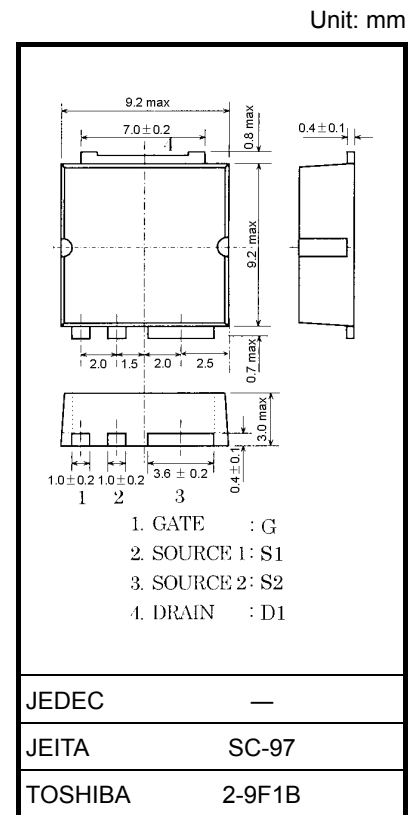
| Characteristics | Symbol | Max | Unit |
|-------------------------------------|----------------|------|------|
| Thermal resistance, channel to case | $R_{th(ch-c)}$ | 1.25 | °C/W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 50 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 800 \mu\text{H}$, $R_G = 25 \Omega$, $I_{AR} = 18 \text{ A}$

Note 3: Repetitive rating: pulse width limited by max junction temperature

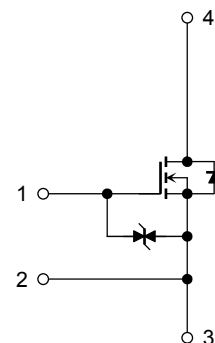
This transistor is an electrostatic-sensitive device.
Please handle with caution.



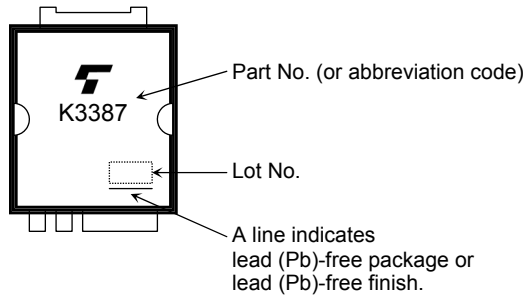
Weight: 0.74 g (typ.)

Notice:

Please use the S1 pin for gate input signal return. Make sure that the main current flows into S2 pin.



Marking



Electrical Characteristics (Note 4) (Ta = 25°C)

| Characteristics | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|---------------|---------------|---|--|------|----------|---------------|
| Gate leakage current | | I_{GSS} | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$ | — | — | ± 10 | μA |
| Drain cut-off current | | I_{DSS} | $V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$ | — | — | 100 | μA |
| Drain-source breakdown voltage | | $V_{(BR)DSS}$ | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$ | 150 | — | — | V |
| Gate threshold voltage | | V_{th} | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ | 0.8 | — | 2.0 | V |
| Drain-source ON resistance | | $R_{DS(ON)}$ | $V_{GS} = 4 \text{ V}, I_D = 9 \text{ A}$ | — | 0.09 | 0.18 | Ω |
| | | | $V_{GS} = 10 \text{ V}, I_D = 9 \text{ A}$ | — | 0.08 | 0.12 | |
| Forward transfer admittance | | $ Y_{fs} $ | $V_{DS} = 10 \text{ V}, I_D = 9 \text{ A}$ | 10 | 17 | — | S |
| Input capacitance | | C_{iss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | — | 1380 | — | pF |
| Reverse transfer capacitance | | C_{rss} | | — | 200 | — | |
| Output capacitance | | C_{oss} | | — | 610 | — | |
| Switching time | Rise time | t_r | | — | 12 | — | ns |
| | Turn-on time | t_{on} | | — | 20 | — | |
| | Fall time | t_f | | — | 12 | — | |
| | Turn-off time | t_{off} | | Duty $\leq 1\%$, $t_w = 10 \mu\text{s}$ | — | 68 | |
| Total gate charge (gate-source plus gate-drain) | | Q_g | $V_{DD} \approx 120 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}$ | — | 57 | — | nC |
| Gate-source charge | | Q_{gs} | | — | 43 | — | nC |
| Gate-drain ("miller") charge | | Q_{gd} | | — | 14 | — | nC |

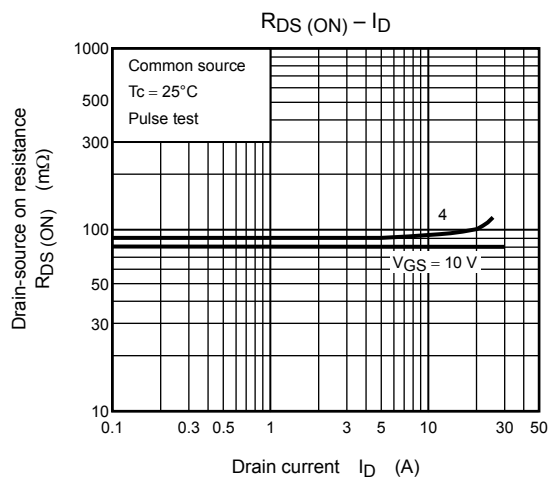
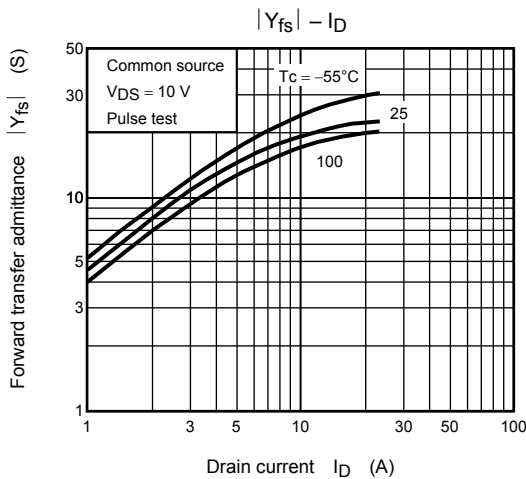
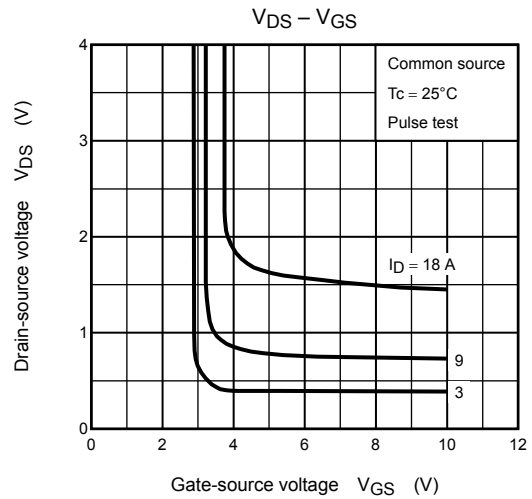
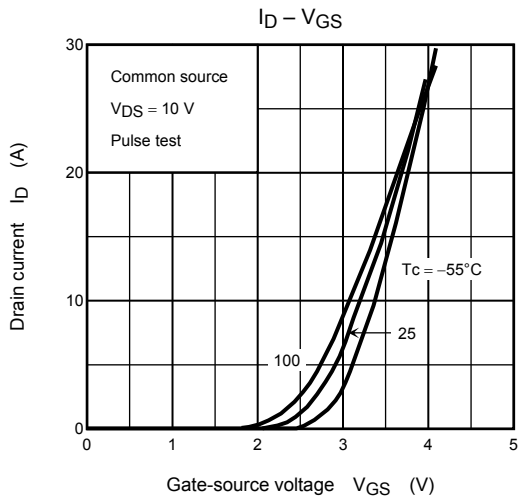
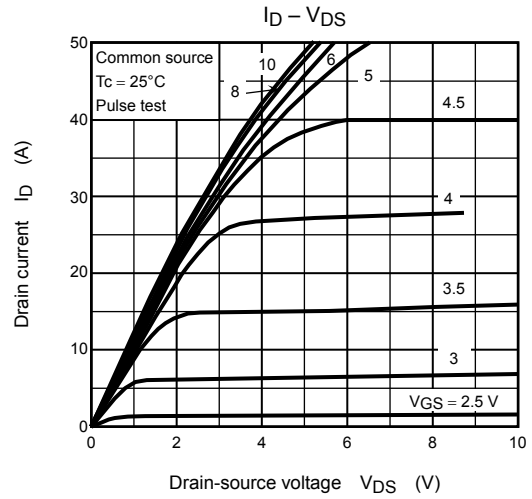
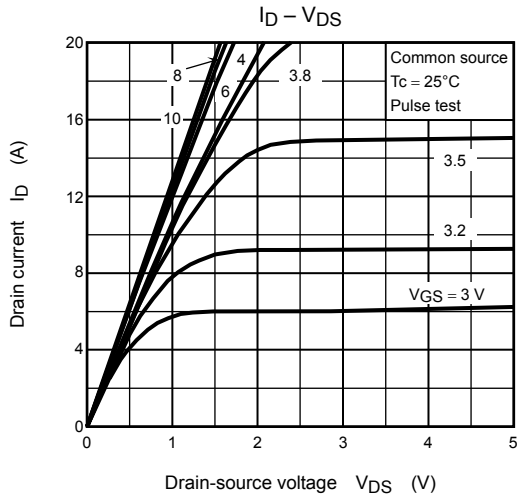
Note 4: Connect the S1 and S2 pins together, and ground them except during switching time measurement.

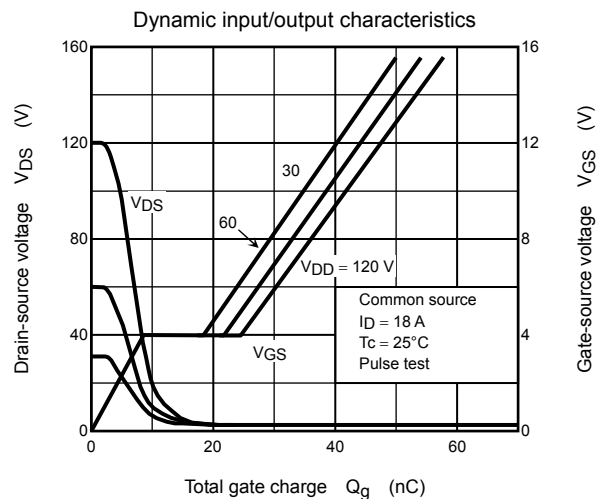
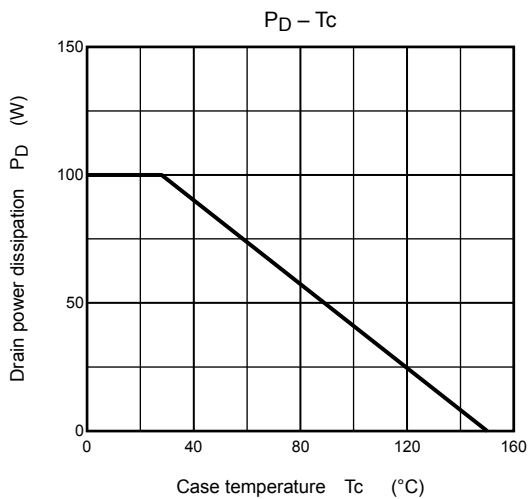
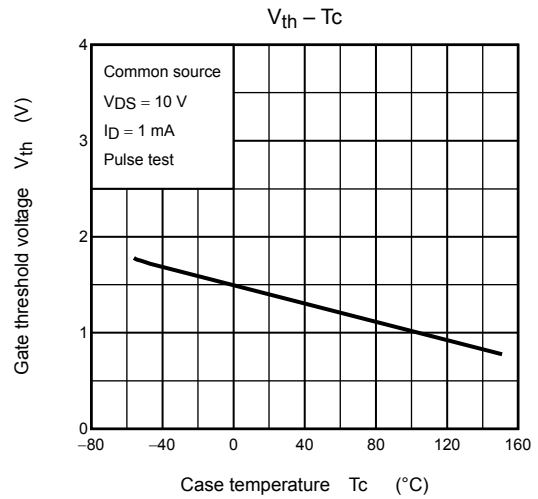
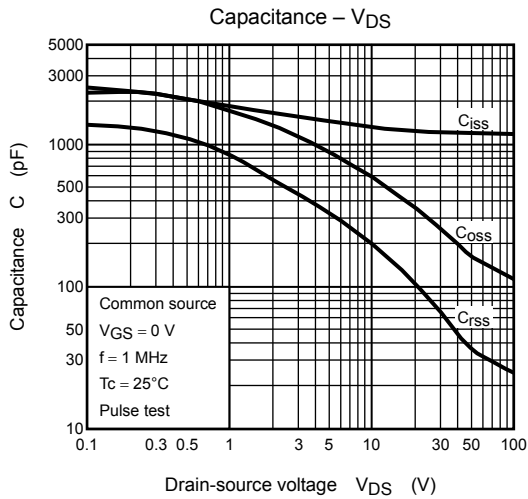
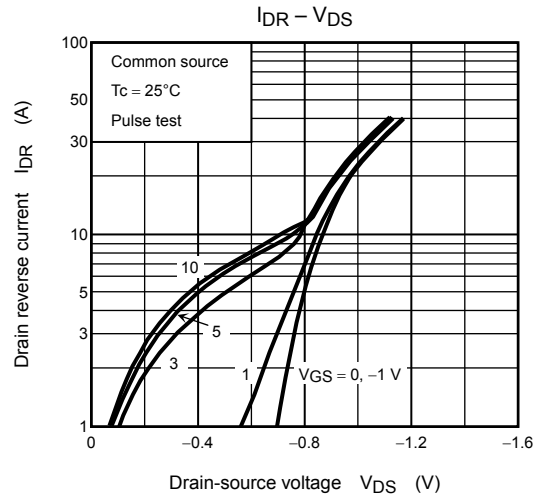
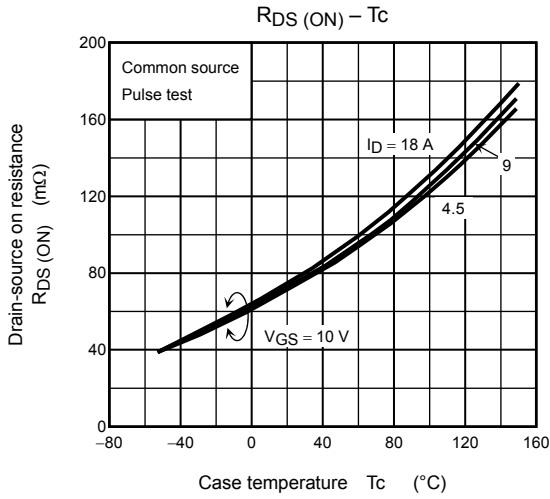
Source-Drain Diode Ratings and Characteristics (Note 5) (Ta = 25°C)

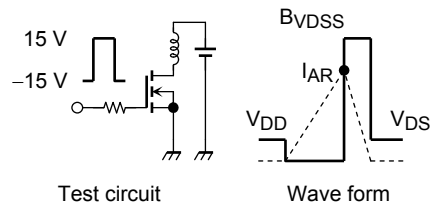
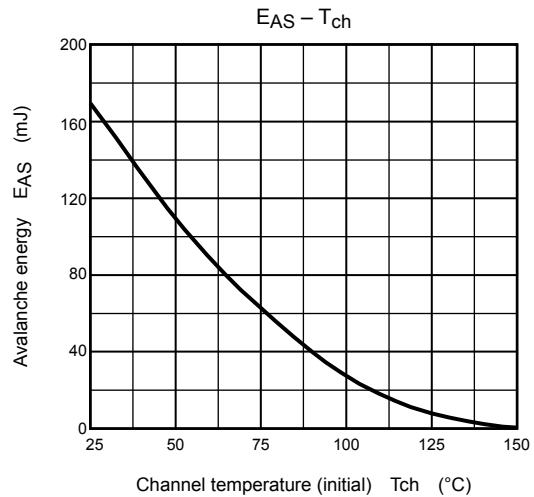
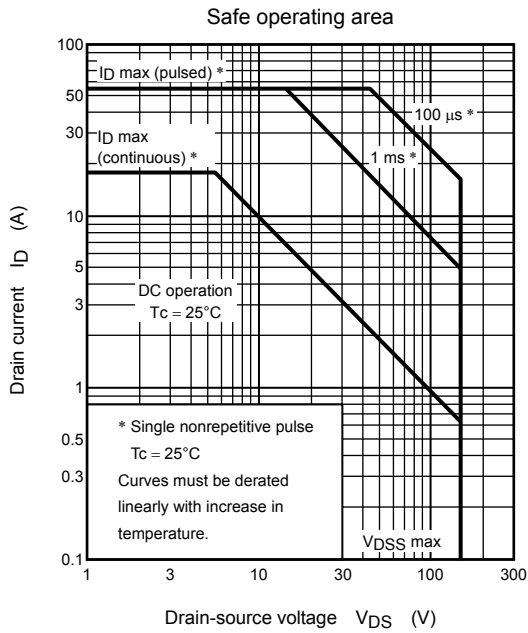
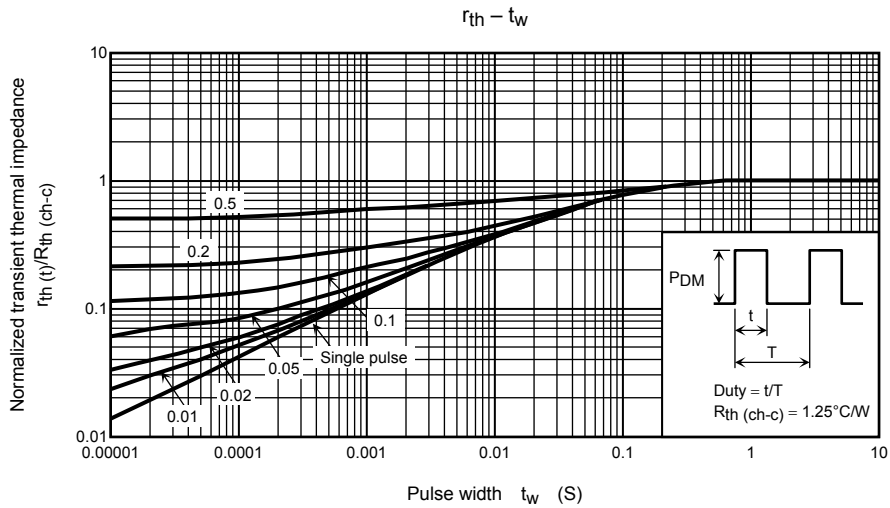
| Characteristics | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|--|--|------------|--|-----|------|------|---------------|
| Continuous drain reverse current (Note 1, 5) | | I_{DR1} | — | — | — | 18 | A |
| Pulse drain reverse current (Note 1, 5) | | I_{DRP1} | — | — | — | 54 | A |
| Continuous drain reverse current (Note 1, 5) | | I_{DR2} | — | — | — | 1 | A |
| Pulse drain reverse current (Note 1, 5) | | I_{DRP2} | — | — | — | 4 | A |
| Diode forward voltage | | V_{DS2F} | $I_{DR1} = 18 \text{ A}, V_{GS} = 0 \text{ V}$ | — | — | -1.7 | V |
| Reverse recovery time | | t_{rr} | $I_{DR} = 18 \text{ A}, V_{GS} = 0 \text{ V},$ | — | 185 | — | ns |
| Reverse recovery charge | | Q_{rr} | $dI_{DR}/dt = 100 \text{ A}/\mu\text{s}$ | — | 1.3 | — | μC |

Note 5: I_{DR1}, I_{DRP1} : Current flowing between the drain and the S2 pin. Ensure that the S1 pin is left open.
 I_{DR2}, I_{DRP2} : Current flowing between the drain and the S1 pin. Ensure that the S2 pin is left open.

Unless otherwise specified, connect the S1 and S2 pins together, and ground them







$$R_G = 25 \Omega$$

$$V_{DD} = 50 V, L = 0.8 mH$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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